

DB-960-90W

90W / 26V / 925-960 MHz PA using 2x PD57060S The *LdmosST* FAMILY

PRELIMINARY DATA

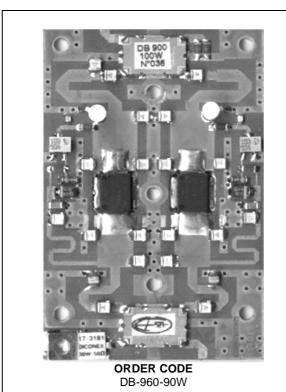
N-CHANNEL ENHANCEMENT-MODE LATERAL MOSFETs

- EXCELLENT THERMAL STABILITY
- COMMON SOURCE CONFIGURATION
- P_{OUT} = 90 W min. with 13 dB gain over 925-960 MHz
- 10:1 LOAD VSWR CAPABILITY
- BeO FREE AMPLIFIER.

DESCRIPTION

The DB-960-90W is a common source N-Channel enhancement-mode lateral Field-Effect RF power amplifier designed for GSM/GPRS/EDGE base station applications.

The DB-960-90W is designed in cooperation with Europeenne de Telecomunications S.A. (www.etsa.rf), for high gain and broadband performance operating in common source mode at 26 V, capable of withstanding load mismatch up to 10:1 all phases and with harmonics lower than 30 dBc.



MECHANICAL SPECIFICATION

L=80 mm W=50 mm H=10 mm

ABSOLUTE MAXIMUM RATINGS (T_{CASE} = 25°C)

| Symbol | Parameter | Value | Unit |
|-------------------|------------------------------|------------|------|
| V _{DD} | Supply voltage | 32 | V |
| I _D | Drain Current | 12 | Α |
| P _{DISS} | Power Diss. at Tcase = +85°C | 145 W | |
| T _{CASE} | Operating Case Temperature | -20 to +85 | °C |
| P _{amb} | Max. Ambient Temperature | +55 | °C |

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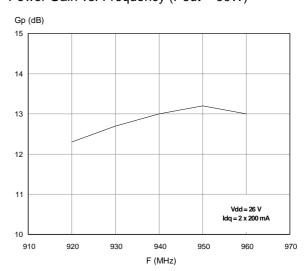
ELECTRICAL SPECIFICATION ($T_{amb} = +25^{\circ}C$, Vdd = 26V, Idq = 2 x 200 mA)

| Symbol | Test Conditions | Min. | Тур. | Max. | Unit |
|------------------------|--|------|------|---------|------|
| FREQ. | Frequency Range | 925 | | 960 | MHz |
| Gain | Pout = 90 W | 12 | 13 | | dB |
| P _{1dB} | Over frequency range: 925 - 960 MHz | 90 | 100 | | W |
| Flatness | Over frequency range and @ P _{OUT} = 90 W | | | +/- 0.5 | dB |
| Flatness | P _{OUT} from 0.1W to 90 W | | | 1 | dB |
| ND at P _{1dB} | P _{1dB} | 40 | 45 | | % |
| IRTL | Input return Loss P _{OUT} from 0.1W to 90 W | | -20 | -15 | dB |
| Harmonic | P _{OUT} = 90 W | | | -30 | dBc |
| VSWR | Load Mismatch all phases @ P _{OUT} = 90 W | 10:1 | | | |
| Spurious | 10:1 VSWR all phases and P _{OUT} from 0.1 to 90 W | | | -76 | dBc |
| IMD ₃ | P _{OUT} = 90 WPEP | | | -25 | dBc |

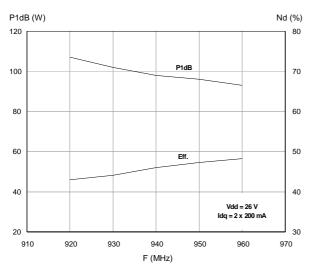
TYPICAL PERFORMANCE Output Power vs. Input Power

Pout (W) 100 80 960 MHz 925 MHz Vdd = 26 V ldq = 2 x 200 mA Pin (W)

Power Gain vs. Frequency (Pout = 90W)

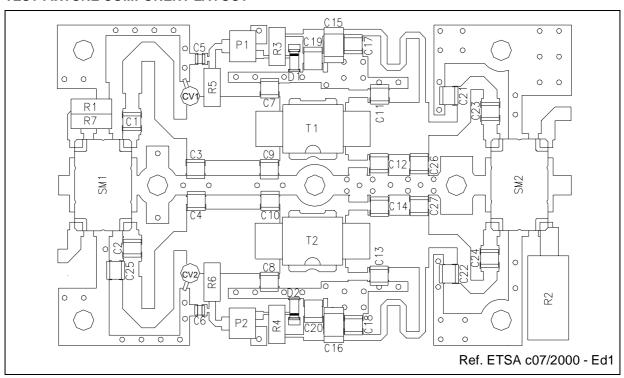


Output Power and Efficiency vs. Frequency

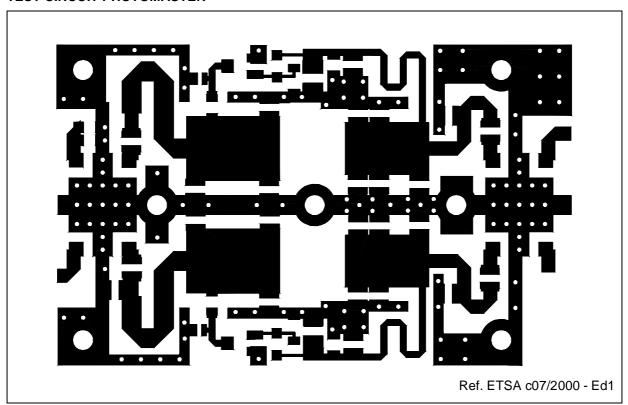


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TEST FIXTURE COMPONENT LAYOUT



TEST CIRCUIT PHOTOMASTER



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DB-960-90W

TEST CIRCUIT COMPONENT PART LIST

| COMPONENT | DESCRIPTION |
|---------------------------|---|
| T1, T2 | PD57060S TRANSISTOR |
| C1, C2, C23, C24 | 47pF - 500V CERAMIC CHIP CAPACITOR |
| C3, C4 | 3.3pF - 500V CERAMIC CHIP CAPACITOR |
| C5, C6, C17, C18 | 100pF - 500V CERAMIC CHIP CAPACITOR |
| C7, C8, C9, C10, C11, C13 | 10pF - 500V CERAMIC CHIP CAPACITOR |
| C12, C14 | 6.8pF - 500V CERAMIC CHIP CAPACITOR |
| C15, C16 | 100nF - 63V CERAMIC CHIP CAPACITOR |
| C19, C20 | 1μF / 35V ELECTROLYTIC CAPACITOR |
| C21, C22, C26, C27 | 3.3pF - 500V CERAMIC CHIP CAPACITOR |
| C25 | 0.5pF - 500V CERAMIC CHIP CAPACITOR |
| CV1, CV2 | ADJUSTABLE CAPACITOR 0.6 - 4.5pF / 500V |
| P1, P2 | 10K Ohms MULTITURN POTENTIOMETER |
| R1,R7 | 100 Ohms 1/4W 1206 SMD CHIP RESISTOR |
| R2 | 50 Ohms 30W - 4GHz LOAD |
| R3, R4 | 4.7K Ohms 1/4W 1206 SMD CHIP RESISTOR |
| R5, R6 | 10K Ohms 1/4W 1206 SMD CHIP RESISTOR |
| D1, D2 | ZENER DIODE 5V - 500 mW SOD80 |
| SM1, SM2 | 90° SMD HYBRID COUPLER ANAREN Xinger 1304-3 |
| BOARD | METCLAD MX3-30-C1/10C THK 0.762 mm Cu 35μ |
| SUBSTRATE | TEFLON-GLASS Er = 2.55 |
| BACK SIDE | COPPER FLANGE 2 mm THICKNESS |
| CERAMIC CHIP CAPACITORS | ATC100B or EQUIVALENT |
| | |

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